5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

General Description

The MAX14948 isolated RS-485/RS-422 transceiver provides $5000V_{RMS}$ (60s) of galvanic isolation between the cable-side (RS-485/RS-422 driver/receiver side) and the UART-side of the device. Isolation improves communication by breaking ground loops and reduces noise when there are large differences in ground potential between ports. This device allows for robust communication up to 500kbps.

The MAX14948 includes one half-duplex drive/receive channel. The receiver is 1/8-unit load, allowing up to 256 transceivers on a common bus.

Integrated true fail-safe circuitry ensures a logic-high on the receiver output when inputs are shorted or open. Undervoltage lockout disables the driver when cable-side or UART-side power supplies are below functional levels.

The driver outputs/receiver inputs are protected from ±30kV electrostatic discharge (ESD) to GNDB on the cable side, as specified by the Human Body Model (HBM).

The MAX14948 is available in a wide body 16-pin SO package and operates over the -40°C to +85°C temperature range.

Benefits and Features

- High-Performance Transceiver Enables Flexible Designs
 - Integrated LDO for Cable-Side Power
 - · Compliant with RS-485/EIA-485 Standard
 - 500kbps Maximum Data Rate
 - · Allows Up to 256 Devices on the Bus
- Integrated Protection Ensure Robust Communication
 - ±30kV ESD (HBM) on Driver Outputs/Receiver Inputs
 - + 5kV_RMS Withstand Isolation Voltage for 60s (V_ISO)
 - 1200V_{PEAK} Maximum Repetitive Peak-Isolation Voltage (VIORM)
 - 848V_{RMS} Maximum Working-Isolation Voltage (V_{IOWM})
 - > 30 Years Lifetime at Rated Working Voltage
 - Withstands ±10kV Surge per IEC 61000-4-5
 - · Thermal Shutdown

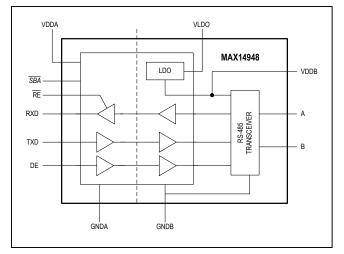
Safety Regulatory Approvals Pending

- UL According to UL1577
- cUL According to CSA Bulletin 5A
- VDE 0884-10

Applications

- Industrial Automation Equipment
- Programmable Logic Controllers
- HVAC
- Power Meters

Functional Diagram



<u>Ordering Information/Selector Guide</u> appears at end of data sheet.



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Absolute Maximum Ratings

V _{DDA} to GNDA	0.3V to +6V
V _{DDB} to GNDB	0.3V to +6V
VI DO to GNDB	0.3V to +16V
TXD, DE, RE to GNDA	0.3V to +6V
SBA, RXD to GNDA	
A, B to GNDB	8V to +13V
Short Circuit Duration (RXD, SBA to GN	IDA,
A, B, V _{DDB} to GNDB)	

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
16-pin W SOIC	
(derate 14.1mW/°C above +70°C)	1126.8mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Thermal Characteristics (Note 1)

Junction-to-Ambient Thermal Resistance (θ_{JA})......71°C/W

Junction-to-Case Thermal Resistance (0_{JC})......23°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

DC Electrical Characteristics

 $(V_{DDA} - V_{GNDA} = 1.71V \text{ to } 5.5V, V_{DDB} - V_{GNDB} = 4.5V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}$, unless otherwise noted. Typical values are at $V_{DDA} - V_{GNDA} = 3.3V$, $V_{DDB} - V_{GNDB} = 5V$, $V_{GNDA} = V_{GNDB}$, and $T_A = +25^{\circ}C$.) (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER						
	V _{DDA}		1.71		5.5	V
Supply Voltage	V _{DDB}		4.5		5.5	v
Supply Current	I _{DDA}	V_{DDA} = 5V, DE = high, \overline{RE} = TXD = low, RXD unconnected, no bus load		4	6.6	m 1
Supply Current	IDDB	DE = high, \overline{RE} = TXD = low, RXD un- connected, no bus load, V _{DDB} = 5V		6.3	12.5	mA
Undervoltage-Lockout Threshold	V _{UVLOA}	V _{DDA} rising	1.50	1.58	1.58 1.65	
Undervoitage-Lockout Theshold	V _{UVLOB}	V _{DDB} rising	2.55	2.55 2.7 2.85		v
Undervoltage-Lockout	VUVHYSTA	IYSTA		50		mV
Threshold Hysteresis	VUVHYSTB			200		
LDO						
LDO Supply Voltage	V _{LDO}	Relative to GNDB, LDO is on (Note 4)	4.68		14	V
LDO Supply Current	ILDO	DE = high, \overline{RE} = TXD = low, no bus load, V _{LDO} = 5.5V		6.5	12.9	mA
LDO Output Voltage	V _{DDB}		4.5	5	5.5	V
LDO Current Limit				300		mA
Load Regulation		V_{LDO} = 5.68V, I_{LOAD} = 20mA to 40mA		0.19	1.7	mV/mA
Line Regulation		V_{LDO} = 5.68V to 14V, I_{LOAD} = 20mA		0.12	1.8	mV/V
Dropout Voltage		V _{LDO} = 4.68V, I _{DDB} = -120mA		100	180	mV

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DC Electrical Characteristics (continued)

 $(V_{DDA} - V_{GNDA} = 1.71V \text{ to } 5.5V, V_{DDB} - V_{GNDB} = 4.5V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{DDA} - V_{GNDA} = 3.3V, V_{DDB} - V_{GNDB} = 5V, V_{GNDA} = V_{GNDB}, \text{ and } T_A = +25^{\circ}C.) \text{ (Notes 2, 3)}$

PARAMETER	SYMBOL	CONE	DITIONS	MIN	TYP	MAX	UNITS
Load Capacitance		Nominal value (Note 6)		1		10	μF
LOGIC INTERFACE (TXD, RXD	, DE, RE, SBA)	1				ı	
Input High Voltage	VIH	RE, TXD, DE to	2.25V ≤ V _{DDA} ≤ 5.5V	0.7 x V _{DDA}			V
input night voltage		GNDA	1.71V ≤ V _{DDA} ≤ 1.89V	0.78 x V _{DDA}			·
Input Low Voltage	VIL	RE, TXD, DE to	2.25V ≤ V _{DDA} ≤ 5.5V			0.8	V
	۷IL	GNDA	1.71V ≤ V _{DDA} ≤ 1.89V			0.6	V
Input Hysteresis	V _{HYS}	RE, TXD, DE to GN	NDA		220		mV
Input Capacitance	C _{IN}	RE, TXD, DE, f = 1	MHz		2		pF
Input Pullup Current	IPU	TXD		-10	-4.5	-1.5	μA
Input Pulldown Current	I _{PD}	DE, RE		1.5	4.5	10	μA
SBA Pullup Resistance	R _{SBA}			3	5	8	kΩ
Output Voltage High	VOH	RXD to GNDA, IO	UT = -4mA	V _{DDA} -0.4			V
		RXD to GNDA, IOL	T = 4mA		0.40	V	
Output Voltage Low	VOL SBA to GNDA, IOUT = 4mA				0.45	V	
Short-Circuit Output Pullup Current	^I SH_PU	$0V \le V_{RXD} \le V_{DD}$ -50mV, \overline{RE} = low	_A , (V _A - V _B) >	-42			mA
Short-Circuit Output Pulldown		$0V \le V_{RXD} \le V_{DD}$ -200mV, RE = low	д, (VA - VB) <			+40	
Current	^I SH_PD	$0V \le V\overline{SBA} \le V_{DD}$, and working	, side B is powered			+60	mA
Tri-State Output Current	IOZ	$0V \le V_{RXD} \le V_{DD}$	A, $\overline{\text{RE}}$ = high	-1		+1	μA
DRIVER		1					
		R _L = 54Ω, TXD = h high, Figure 1a	igh or low, DE =	2			
Differential Driver Output	IVODI	R _L = 100Ω, TXD = high, Figure 1a	high or low, DE =	3			V
		$-7V \le V_{CM} \le +12V$, Figure 1b		1.5		5	
Change in Magnitude of Differential Driver Output Voltage	ΔV _{OD}	$R_L = 54\Omega$ (Note 5)				0.2	V
Driver Common Mode Output Voltage	V _{OC}	R _L = 54Ω			V _{DDB} /2	3	V
Change in Magnitude of Common-Mode Voltage	ΔV _{OC}	R _L = 54Ω, (Note 5)				0.2	V

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DC Electrical Characteristics (continued)

 $(V_{DDA} - V_{GNDA} = 1.71V \text{ to } 5.5V, V_{DDB} - V_{GNDB} = 4.5V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{DDA} - V_{GNDA} = 3.3V, V_{DDB} - V_{GNDB} = 5V, V_{GNDA} = V_{GNDB}, \text{ and } T_A = +25^{\circ}C.) \text{ (Notes 2, 3)}$

PARAMETER	SYMBOL	CON	DITIONS	MIN	TYP	MAX	UNITS	
Driver Short-Circuit Output	1	$GNDB \le V_{OUT} \le (Note 6)$	+12V, output low	+40		+250	mA	
Current	IOSD	$-7V \le V_{OUT} \le V_{D}$ (Note 6)	DB, output high	-250		-40		
Driver Short-Circuit Foldback	IOSDF	$(V_{DDB} - 1V) \le V_{C}$ low (Note 6))UT ≤ +12V, output	+20			mA	
Output Current	-03DF	$-7V \le V_{OUT} \le +1V$, output high (Note 6)				-20		
RECEIVER								
			V _{IN} = +12V			+125	μA	
Input Current (A and B)	I _A , I _B		V _{IN} = -7V	-100				
Receiver Differential Threshold Voltage	V _{TH}	-7V ≤ V _{CM} ≤ +12V		-200	-125	-50	mV	
Receiver Input Hysteresis	ΔV_{TH}	V _{CM} = 0V			15		mV	
Receiver Input Resistance	R _{IN}	$-7V \le V_{CM} \le +12V$	/, DE = low	96			kΩ	
PROTECTION								
Thermal-Shutdown Threshold	T _{SHDN}	Temperature Risin	ıg		+160		°C	
Thermal-Shutdown Hysteresis	T _{HYST}				15		°C	
		Human Body Model			±30			
ESD Protection (A and B Pins to GNDB)		IEC 61000-4-2 Air	Gap Discharge	1	±15	kV		
		IEC 61000-4-2 Co	ntact Discharge	±10				
ESD Protection (All Other Pins)		Human Body Mod	el		±4		kV	

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Switching Electrical Characteristics

 $(V_{DDA} - V_{GNDA} = 1.71V \text{ to } 5.5V, V_{DDB} - V_{GNDB} = 4.5V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}$, unless otherwise noted. Typical values are at $V_{DDA} - V_{GNDA} = 3.3V$, $V_{DDB} - V_{GNDB} = 5V$, $V_{GNDA} = V_{GNDB}$, and $T_A = +25^{\circ}C$.) (Note 7)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DYNAMIC					· · · · ·	
Common Mode Transient Immunity	СМТІ	(Note 8)		35		kV/µs
Glitch Rejection		TXD, DE, RXD	10	17	29	ns
DRIVER						
Driver Propagation Delay	^t DPLH, ^t DPHL	$R_L = 54\Omega$, $C_L = 50pF$, Figure 2 and Figure 3			1040	ns
Differential Driver Output Skew ^t DPLH ⁻ ^t DPHL	^t DSKEW	$R_L = 54\Omega$, $C_L = 50pF$, Figure 2 and Figure 3			144	ns
Driver Differential Output Rise or Fall Time	tLH ^{, t} HL	$R_L = 54\Omega$, $C_L = 50pF$, Figure 2 and Figure 3			900	ns
Maximum Data Rate	DRMAX		500			kbps
Driver Enable to Output High	^t DZH	R _L = 500Ω, C _L = 50pF, Figure 4			2540	ns
Driver Enable to Output Low	^t DZL	RL = 500Ω, CL = 50pF, Figure 5			2540	ns
Driver Disable Time from Low	^t DLZ	R _L = 500Ω, C _L = 50pF, Figure 5			140	ns
Driver Disable Time from High	^t DHZ	$R_L = 500\Omega$, $C_L = 50pF$, Figure 4			140	ns
RECEIVER						
Receiver Propagation Delay	^t RPLH, ^t RPHL	C _L = 15pF, Figure 6 and Figure 7 (Note 9)			240	ns
Receiver Output Skew ^t RPLH ^{- t} RPHL	^t RSKEW	C _L = 15pF, Figure 6 and Figure 7 (Note 9)			34	ns
Maximum Data Rate	DRMAX		500			kbps
Receiver Enable to Output High	^t RZH	$R_L = 1k\Omega$, $C_L = 15pF$, S2 closed, Figure 8			20	ns
Receiver Enable to Output Low	^t RZL	$R_L = 1k\Omega$, $C_L = 15pF$, S1 closed, Figure 8			30	ns
Receiver Disable Time From Low	^t RLZ	$R_L = 1k\Omega$, $C_L = 15pF$, S1 closed, Figure 8			20	ns
Receiver Disable Time From High	^t RHZ	R _L = 1kΩ, C _L = 15pF, S2 closed, Figure 8			20	ns

Note 2: All devices are 100% production tested at $T_A = +25^{\circ}C$. Specifications over temperature are guaranteed by design.

Note 3: All currents into the device are positive. All currents out of the device are negative. All voltages are referenced to their respective ground (GNDA or GNDB), unless otherwise noted.

Note 4: V_{LDO} max indicates voltage capability of the circuit. Power dissipation requirements may limit V_{LDO} max to a lower value.

Note 5: ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when the TXD input changes state.

Note 6: The short circuit output current applies to the peak current just prior to foldback current limiting.

Note 7: Not production tested. Guaranteed by design.

Note 8: CMTI is the maximum sustainable common-mode voltage slew rate while maintaining the correct output states. CMTI applies to both rising and falling common-mode voltage edges. Tested with the transient generator connected between GNDA and GNDB.

Note 9: Capacitive load includes test probe and fixture capacitance.

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Insulation Characteristics

PARAMETER	SYMBOL	CONDITIONS	VALUE	UNITS
Partial Discharge Test Voltage	V _{PR}	Method B1 = V _{IORM} x 1.875 (t = 1s, partial discharge < 5pC)	2250	VP
Maximum Repetitive Peak Withstand Voltage	VIORM	(Note 10)	1200	VP
Maximum Working-Isolation Voltage	VIOWM	(Note 10)	848	VRMS
Maximum Transient Isolation Voltage	VIOTM	t = 1s	8400	VP
Maximum Withstand-Isolation Voltage	VISO	t = 60s, f = 60Hz (Notes 10, 11)	5000	VRMS
Maximum Surge Isolation Voltage	VIOSM	IEC61000-4-5, 1.2/50μs	10	kV
Insulation Resistance	RS	T _A = +150°C, V _{IO} = 500V	>10 ⁹	Ω
Barrier Capacitance Input to Output	CIO	f = 1MHz	2	pF
Minimum Creepage Distance	CPG	Wide SOIC	8	mm
Minimum Clearance Distance	CLR	Wide SOIC	8	mm
Internal Clearance		Distance through insulation	0.015	mm
Comparative Tracking Resistance Index	СТІ	Material Group II (IEC 60112)	575	
Climatic Category			40/125/21	
Pollution Degree (DIN VDE 0110, Table 1)			2	

Note 10: V_{IORM} , V_{IOWM} , and V_{ISO} are defined by the IEC 60747-5-5 standard. **Note 11:** Product is qualified at V_{ISO} for 60 seconds. 100% production tested at 120% of V_{ISO} for 1 second.

Safety Regulatory Approvals (Pending)

UL
The MAX14948 is certified under UL1577. For more details, see File E351759.
Rate up to 5000V _{RMS} isolation voltage for basic insulation.
cUL
Pending
VDE
Pending
TUV
Pending

5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

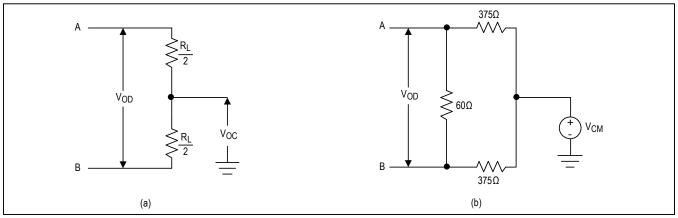


Figure 1. Driver DC Test Load

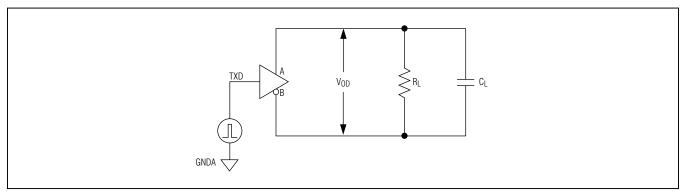


Figure 2. Driver Timing Test Circuit

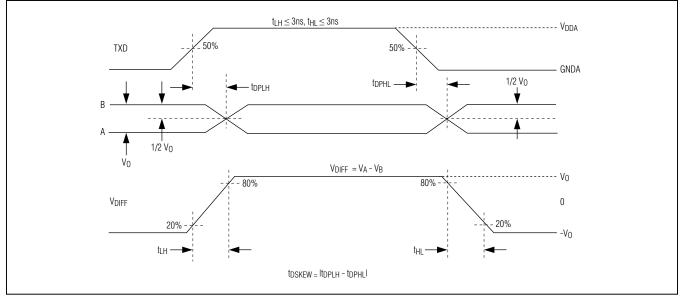


Figure 3. Driver Propagation Delays

5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

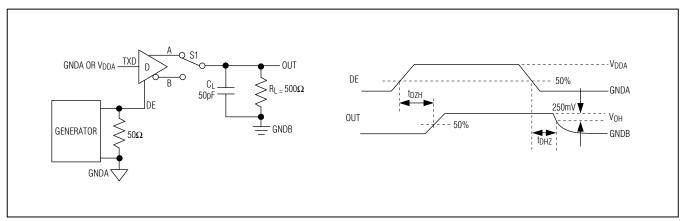


Figure 4. Driver Enable and Disable Times (t_{DHZ}, t_{DZH})

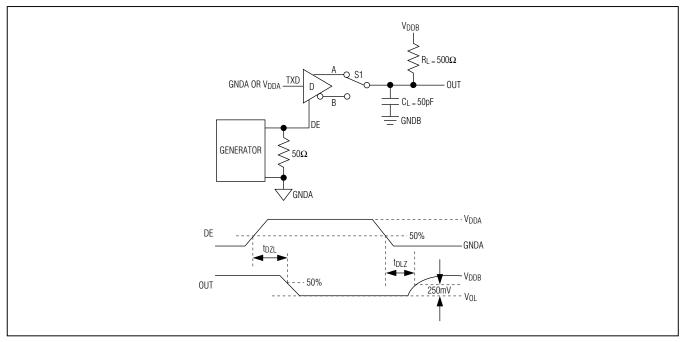


Figure 5. Driver Enable and Disable Times (t_{DZL}, t_{DLZ})

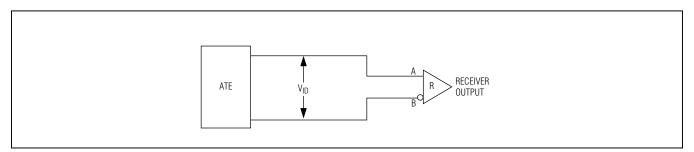


Figure 6. Receiver Propagation Delay Test Circuit

5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

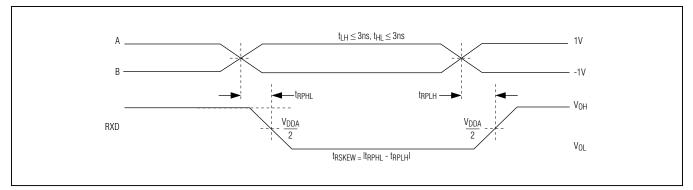


Figure 7. Receiver Propagation Delays

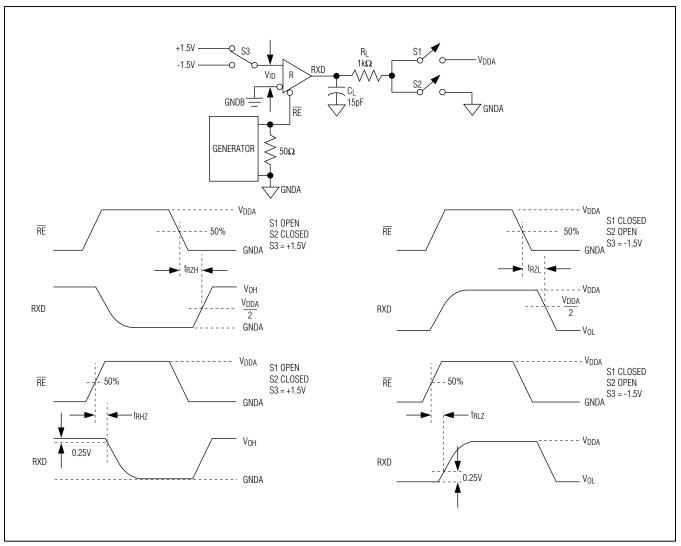
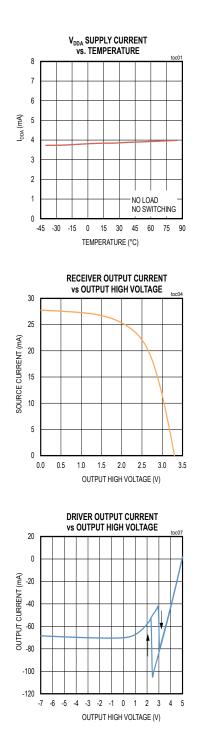


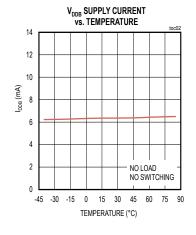
Figure 8. Receiver Enable and Disable Times

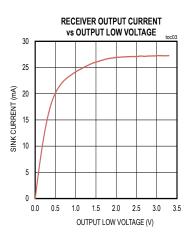
$5kV_{RMS}$ Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with $\pm 30kV$ ESD Protection

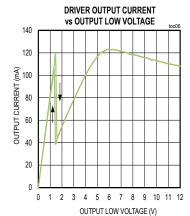
Typical Operating Characteristics

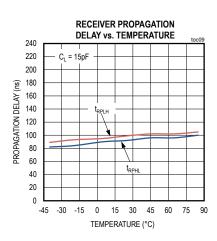
(VDDA - VGNDA = 3.3V, VDDB - VGNDB = 5V, VGNDA = VGNDB, and TA = +25°C, unless otherwise noted.)











vs. TEMPERATURE 5.5 No load 5.0 4.5 4.0 ≥ 3.5 ₿ 3.0 120Ω LOAD 2.5 54Ω LOAD 2.0 1.5 1.0 0.5 0.0 -45 -30 -15 0 15 30 45 60 75 90 TEMPERATURE (°C)

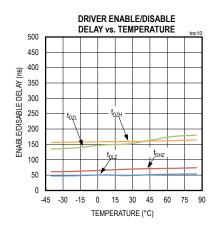
DIFFERENTIAL OUTPUT VOLTAGE

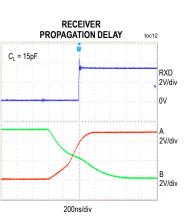
TRANSMITTER PROPAGATION **DELAY vs. TEMPERATURE** 1000 900 800 PROPAGATION DELAY (ns) 700 600 500 400 300 200 $R_L = 54\Omega$ $C_1 = 50pF$ 100 0 -45 -30 -15 0 15 30 45 60 75 90 TEMPERATURE (°C)

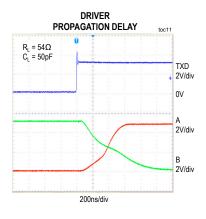
5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

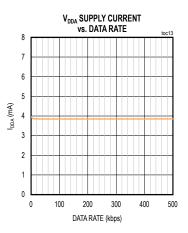
Typical Operating Characteristics (continued)

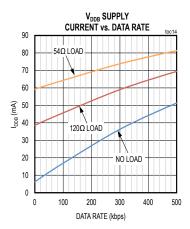
(VDDA - VGNDA = 3.3V, VDDB - VGNDB = 5V, VGNDA = VGNDB, and TA = +25°C, unless otherwise noted.)





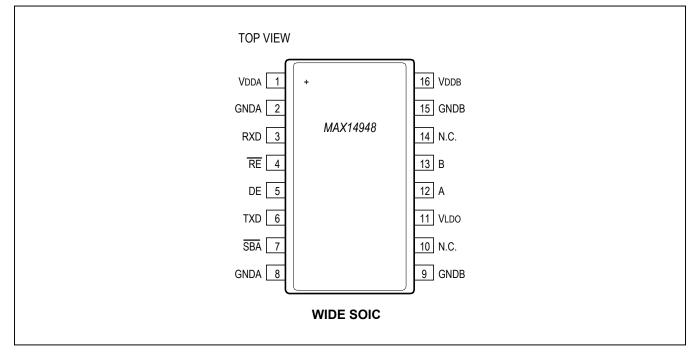






5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

Pin Configuration



Pin Description

PIN	NAME	REFERENCE	FUNCTION
1	V _{DDA}	GNDA	UART/Logic-Side Power Input. Bypass $V_{\mbox{DDA}}$ to GNDA with both 0.1µF and 1µF capacitors as close to the device as possible.
2, 8	GNDA	-	UART/Logic-Side Ground. GNDA is the ground reference for digital signals.
3	RXD	GNDA	Receiver Data Output. Drive \overline{RE} low to enable RXD. With \overline{RE} low, RXD is high when (V _A – V _B) > -50mV and is low when (V _A – V _B) < -200mV. RXD is high when V _{DDB} is less than V _{UVLOB} . RXD is high impedance when \overline{RE} is high.
4	RE	GNDA	Receiver Output Enable. Driver \overline{RE} low or connect to GNDA to enable RXD. Drive \overline{RE} high to disable RXD. RXD is high-impedance when \overline{RE} is high. \overline{RE} has an internal 4.5µA pull-down to GNDA.

5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

Pin Description (continued)

PIN	NAME	REFERENCE	FUNCTION
5	DE	GNDA	Driver Output Enable. Drive DE high to enable bus driver outputs A and B. Drive DE low or connect to GNDA to disable A and B. A and B are high impedance when DE is low. DE has an internal 4.5μ A pull-down to GNDA.
6	TXD	GNDA	Driver Input. With DE high, a low on TXD forces the noninverting output (A) low and the inverting output (B) high. Similarly, a high on TXD forces the noninverting output high and the inverting output low. TXD has an internal 4.5μ A pull-up to V _{DDA} .
7	SBA	GNDA	Side B Active Indicator Output. \overline{SBA} asserts low when side B is powered and working. \overline{SBA} has an internal $5k\Omega$ pull-up resistor to V_{DDA} .
9, 15	GNDB	-	Cable-Side Ground. GNDB is the ground reference for the internal LDO and the RS-485/RS-422 bus signals.
10, 14	N.C.	-	No Connection. Not internally connected.
11	VLDO	GNDB	LDO Power Input. Connect a minimum voltage of 4.68V to V _{LDO} to power the cable-side of the transceiver. Bypass V _{LDO} to GNDB with both 0.1 μ F and 1 μ F capacitors as close to the device as possible. To disable the internal LDO, leave V _{LDO} unconnected or connect to GNDB.
12	A	GNDB	Noninverting Receiver Input and Noninverting Driver Output
13	В	GNDB	Inverting Receiver Input and Inverting Driver Output
16	VDDB	GNDB	Cable-Side Power Input/Isolated LDO Power Output. Bypass V _{DDB} to GNDB with both 0.1µF and 1µF capacitor as close as possible to the device. V _{DDB} is the output of the internal LDO when power is applied to V _{LDO} . When the internal LDO is not used (V _{LDO} is unconnected or connected to GNDB), V _{DDB} is the positive supply input for the cable-side of the IC.

5kV_{RMS} Isolated 500kbps Half-Duplex RS-485/ RS-422 Transceiver with ±30kV ESD Protection

Function Tables

	TRANSMITTING						
	INP	OUT	PUTS				
V _{DDA}	V _{DDB}	DE	TXD	A	В		
≥ V _{UVLOA}	≥ V _{UVLOB}	1	1	1	0		
≥ V _{UVLOA}	≥ V _{UVLOB}	1	0	0	1		
≥ V _{UVLOA}	≥ V _{UVLOB}	0	X	High-Z	High-Z		
< V _{UVLOA}	≥ V _{UVLOB}	Х	X	High-Z	High-Z		
≥ V _{UVLOA}	< V _{UVLOB}	Х	X	High-Z	High-Z		
< V _{UVLOA}	< V _{UVLOB}	Х	Х	High-Z	High-Z		

*Note: Drive DE low to disable the transmitter outputs. Drive DE high to enable the transmitter outputs. DE has an internal pull-down to GNDA.

X = Don't care

	RECEIVING								
	INPUTS								
V _{DDA}	V _{DDB}	RE	(V _A - V _B)	RXD					
≥ V _{UVLOA}	≥ V _{UVLOB}	0	> -50mV	1					
≥ V _{UVLOA}	≥ V _{UVLOB}	0	< -200mV	0					
≥ V _{UVLOA}	≥ V _{UVLOB}	0	Open/Short	1					
≥ V _{UVLOA}	≥ V _{UVLOB}	1	Х	High-Z					
< V _{UVLOA}	≥ V _{UVLOB}	Х	X	High-Z					
≥ V _{UVLOA}	< V _{UVLOB}	0	X	1					
< V _{UVLOA}	< V _{UVLOB}	Х	Х	High-Z					

*Note: Drive \overline{RE} high to disable the receiver output. Drive \overline{RE} low to enable to receiver output. \overline{RE} has an internal pull-down to GNDA.

X = Don't care

SBA				
V _{DDA}	V _{DDB}	SBA		
< V _{UVLOA}	< V _{UVLOB}	High		
< V _{UVLOA}	≥ V _{UVLOB}	High		
≥ V _{UVLOA}	< V _{UVLOB}	High		
≥ V _{UVLOA}	≥ V _{UVLOB}	Low		

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Detailed Description

The MAX14948 isolated RS-485/RS-422 transceiver provides $5000V_{RMS}$ (60s) of galvanic isolation between the RS-485/RS-422 cable side of the transceiver and the UART side. This device allows up to 500kbps communication across an isolation barrier when a large potential exists between grounds on each side of the barrier.

Isolation

Data isolation is achieved using integrated capacitive isolation that allows data transmission between the UART side and the cable side of the transceiver.

Integrated LDO

The device includes an internal low-dropout regulator with a set 5V (typ) output that is used to power the cable side of the IC. The output of the LDO is V_{DDB} . The LDO has a 300mA (typ) current limit. If the LDO is unused, connect V_{LDO} to GNDB and apply +5V directly to V_{DDB} .

True Fail-Safe

The device guarantees a logic-high on the receiver output when the receiver inputs are shorted or open, or when connected to a terminated transmission line with all drivers disabled. The receiver threshold is fixed between -50mV and -200mV. If the differential receiver input voltage ($V_A - V_B$) is greater than or equal to -50mV, RXD is logic-high. In the case of a terminated bus with all transmitters disabled, the receiver's differential input voltage is pulled to zero by the termination resistors. Due to the receiver thresholds of the device, this results in a logic-high at RXD.

Driver Output Protection

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. The first, a foldback mode current limit on the output stage, provides immediate protection against short circuits over the entire common-mode voltage range. The second, a thermal-shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature exceeds $+160^{\circ}C$ (typ).

Thermal Shutdown

The device is protected from overtemperature damage by integrated thermal shutdown circuitry. When the junction temperature (T_J) exceeds +160°C (typ), the driver outputs go high impedance. The device resumes normal operation when T_J falls below +145°C (typ).

Applications Information

256 Transceivers on the Bus

The standard RS-485 receiver input impedance is one unit load, and a standard driver can drive up to 32 unit loads. The device transceiver has a 1/8-unit load receiver, which allows up to 256 transceivers connected in parallel on one communication line. Connect any combination of these devices, and/or other RS-485/RS-422 devices, for a maximum of 32 unit loads to the line.

Typical Application

The transceiver is designed for bidirectional data communications on multipoint bus-transmission lines. Figure 9 shows typical network application circuits. To minimize reflections, the bus should be terminated at both ends in its characteristics impedance, and stub lengths off the main line should be kept as short as possible.

Layout Considerations

It is recommended to design an isolation or keep out channel underneath the isolator that is free from ground and signal planes. Any galvanic or metallic connection between the cable side and UART side defeats the isolation.

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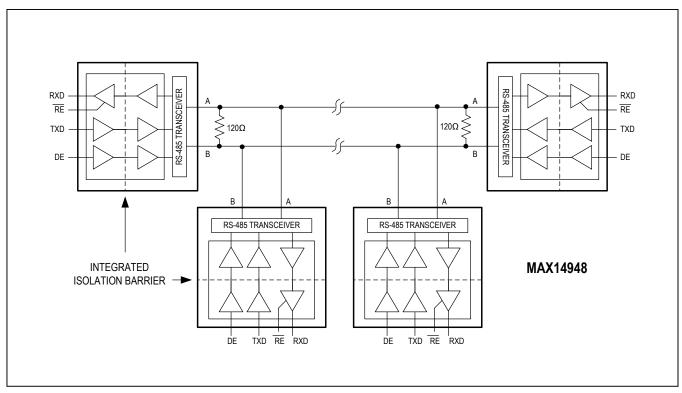


Figure 9. Typical Isolated Half-Duplex RS-485 Application

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Ensure that the decoupling capacitors between V_{DDA} and GNDA and between V_{LDO} , V_{DDB} , and GNDB are located as close as possible to the IC to minimize inductance.

Route important signal lines close to the ground plane to minimize possible external influences. On the cable side of the device, it is good practice to have the bus connectors and termination resistor as close as possible to the A and B pins.

Extended ESD Protection

ESD-protection structures are incorporated on all pins to protect against electrostatic discharge encountered during handling and assembly. The driver outputs and receiver inputs of the MAX14948 have extra protection against static electricity. The ESD structures withstand high ESD in normal operation and when powered down. After an ESD event, the devices keep working without latchup or damage.

Bypass V_{DDA} to GNDA and bypass V_{DDB} and V_{LDO} to GNDB with 0.1µF and 1µF capacitors to ensure maximum ESD protection.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the device are characterized for protection to the cable-side ground (GNDB) to the following limits:

- ±30kV HBM
- ±15kV using the Air-Gap Discharge method specified in IEC 61000-4-2
- ±10kV using the Contact Discharge method specified in the IEC 61000-4-2

ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

Human Body Model (HBM)

<u>Figure 10</u> shows the HBM test model and <u>Figure 11</u> shows the current waveform it generates when discharged in a low-impedance state. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged in to the test device through a $1.5 k\Omega$ resistor.

IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The device helps in designing equipment to meet IEC 61000-4-2 without the need for additional ESD-protection components.

The major difference between tests done using the HBM and IEC 61000-4-2 is higher peak current in IEC 61000-4-2 because series resistance is lower in the IEC 61000-4-2 model. Hence, the ESD withstand voltage measured to IEC 61000-4-2 is generally lower than that measured using the HBM.

Figure 12 shows the IEC 61000-4-2 model and Figure 13 shows the current waveform for IEC 61000-4-2 ESD Contact Discharge Test.

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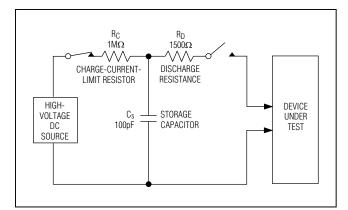


Figure 10. Human Body ESD Test Model

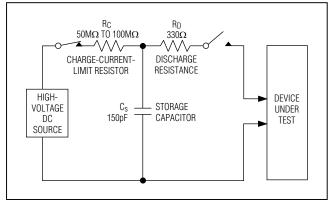


Figure 12. IEC 61000-4-2 ESD Test Model

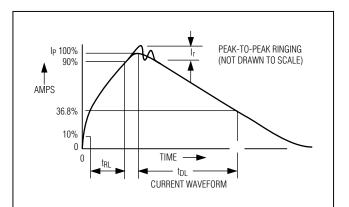


Figure 11. Human Body Current Waveform

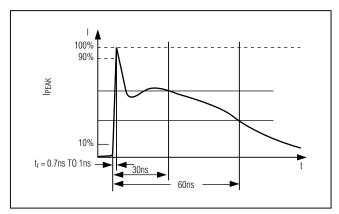
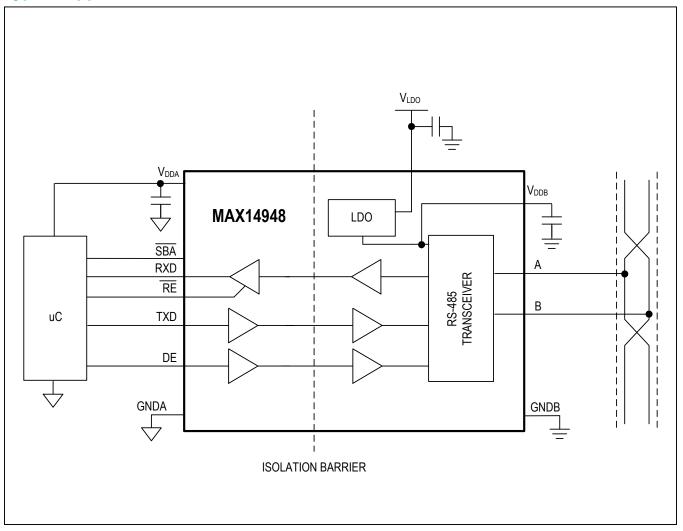


Figure 13. IEC 61000-4-2 ESD Generator Current Waveform

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Typical Application Circuit



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Ordering Information/Selector Guide

PART	TEMP RANGE	PIN- PACKAGE	
MAX14948EWE+	-40°C to +85°C	16 SOIC (W)	
MAX14948EWE+T	-40°C to +85°C	16 SOIC (W)	

+Denotes a lead(Pb)-free/RoHS-compliant package. T = Tape and reel.

Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND PATTERN
TYPE	CODE	NO.	NO.
16 SOIC	W16M+9	<u>21-0042</u>	<u>90-0107</u>

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Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	11/15	Initial release	—

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